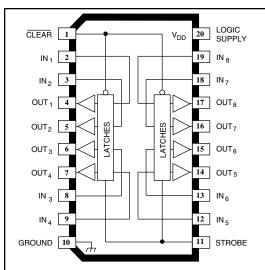
ADVANCE INFORMATION

(Subject to change without notice)
January 24, 2000



Dwg. PP-015-2

Note that the A6273KA (DIP) and the A6273KLW (SOIC) are electrically identical and share a common terminal number assignment.

ABSOLUTE MAXIMUM RATINGS at $T_{\Delta} = 25^{\circ}C$

**
Output Voltage, V _O 50 V
Output Drain Current,
Continuous, I _O 250 mA*
Peak, I _{OM} 750 mA*†
Peak, I _{OM} 2.0 A †
Single-Pulse Avalanche Energy,
E _{AS} 75 mJ
Logic Supply Voltage, V _{DD} 7.0 V
Input Voltage Range,
V _I 0.3 V to +7.0 V
Package Power Dissipation,
P _D See Graph
Operating Temperature Range,
T_A 40°C to +125°C
Storage Temperature Range,
T_S 55°C to +150°C
* Each output, all outputs on.
171 1 1 100 100

† Pulse duration $\leq 100 \mu s$, duty cycle $\leq 2\%$. Caution: These CMOS devices have input static protection (Class 3) but are still susceptible to damage if exposed to extremely

high static electrical charges.

8-BIT LATCHED DMOS POWER DRIVER

The A6273KA and A6273KLW combine eight (positive-edge-triggered D-type) data latches and DMOS outputs for systems requiring relatively high load power. Driver applications include relays, solenoids, and other medium-current or high-voltage peripheral power loads. The CMOS inputs and latches allow direct interfacing with microprocessor-based systems. Use with TTL may require appropriate pull-up resistors to ensure an input logic high.

The DMOS output inverts the DATA input. All of the output drivers are disabled (the DMOS sink drivers turned OFF) with the CLEAR input low. The A6273KA/KLW DMOS open-drain outputs are capable of sinking up to 750 mA. Similar devices with reduced $r_{DS(on)}$ will be available as the A6A273.

The A6273KA is furnished in a 20-pin dual in-line plastic package. The A6273KLW is furnished in a 20-lead wide-body, small-outline plastic package (SOIC) with gull-wing leads for surface-mount applications. Copper lead frames, reduced supply current requirements, and low on-state resistance allow both devices to sink 150 mA from all outputs continuously, to ambient temperatures over 85°C.

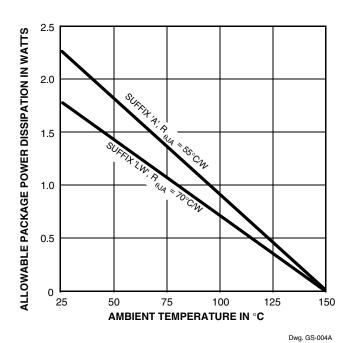
FEATURES

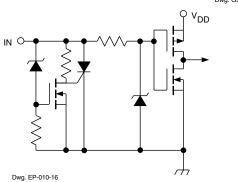
- 50 V Minimum Output Clamp Voltage
- 250 mA Output Current (all outputs simultaneously)
- 1.3 Ω Typical $r_{DS(on)}$
- Low Power Consumption
- Replacements for TPIC6273N and TPIC6273DW

Always order by complete part number:

Part Number	Package	$R_{ heta JA}$	$R_{ heta JC}$
A6273KA	20-pin DIP	55°C/W	25°C/W
A6273KLW	20-lead SOIC	70°C/W	17°C/W

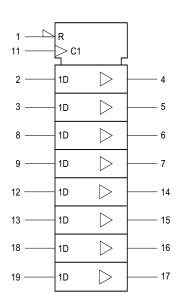




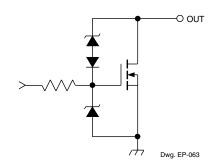


LOGIC INPUTS

LOGIC SYMBOL



Dwg. FP-046-1



DMOS POWER DRIVER OUTPUT

FUNCTION TABLE

CLEAR	Inputs STROBE	IN _X	OUT _X
L	Х	Х	Н
Н	厶	Н	L
Н	厶	L	Н
Н	L	X	R

L = Low Logic Level

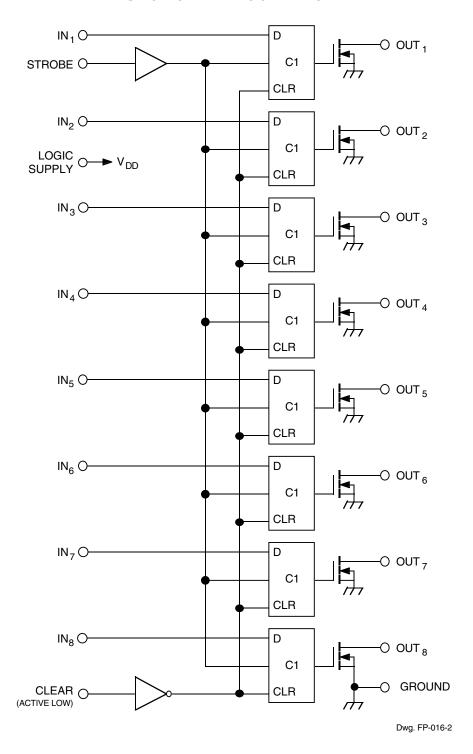
H = High Logic Level

X = Irrelevant

R = Previous State



FUNCTIONAL BLOCK DIAGRAM



RECOMMENDED OPERATING CONDITIONS

over operating temperature range

Logic Supply Voltage Range, V _{DD}	4.5 V to 5.5 V
High-Level Input Voltage, V _{IH}	≥ 0.85V _{DD}
Low-level input voltage, V _{II}	≤0.15V _{DD}

ELECTRICAL CHARACTERISTICS at T_A = +25°C, V_{DD} = 5 V, t_{ir} = $t_{if} \le 10$ ns (unless otherwise specified).

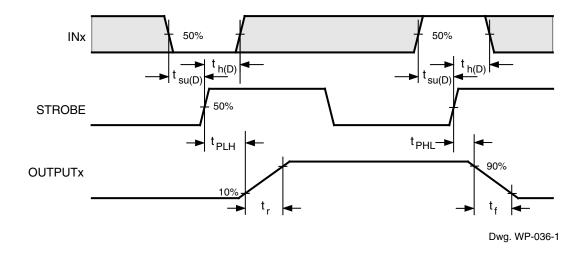
				Lin	nits	
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Logic Supply Voltage	V _{DD}	Operating	4.5	5.0	5.5	V
Output Breakdown Voltage	$V_{(BR)DSX}$	I _O = 1 mA	50	_	_	V
Off-State Output	I _{DSX}	V _O = 40 V	_	0.05	1.0	μА
Current		V _O = 40 V T _A = 125°C	_	0.15	5.0	μА
Static Drain-Source	r _{DS(on)}	I _O = 250 mA, V _{DD} = 4.5 V		1.3	2.0	Ω
On-State Resistance		I _O = 250 mA, V _{DD} = 4.5 V, T _A = 125°C	_	2.0	3.2	Ω
		I _O = 500 mA, V _{DD} = 4.5 V (see note)	_	1.3	2.0	Ω
Nominal Output Current	I _{O(nom)}	V _{DS(on)} = 0.5 V, T _A = 85°C	_	250	_	mA
Logic Input Current	I _{IH}	V _I = V _{DD} = 5.5 V	_	_	1.0	μА
	I _{IL}	V _I = 0, V _{DD} = 5.5 V	_	_	-1.0	μА
Prop. Delay Time	t _{PLH}	I _O = 250 mA, C _L = 30 pF	_	625		ns
	t _{PHL}	I _O = 250 mA, C _L = 30 pF	_	150	_	ns
Output Rise Time	t _r	I _O = 250 mA, C _L = 30 pF	_	675	_	ns
Output Fall Time	t _f	I _O = 250 mA, C _L = 30 pF	_	400		ns
Supply Current	I _{DD(off)}	V _{DD} = 5.5 V, Outputs OFF	_	15	100	μΑ
	I _{DD(on)}	V _{DD} = 5.5 V, Outputs ON	_	150	300	μΑ

Typical Data is at $V_{DD} = 5 \text{ V}$ and is for design information only.

NOTE — Pulse test, duration $\leq 100 \,\mu s$, duty cycle $\leq 2\%$.

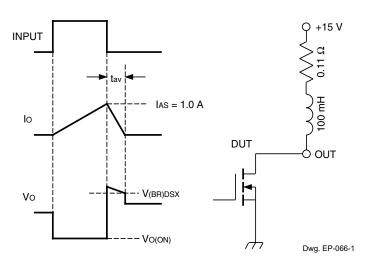


TIMING REQUIREMENTS



Input Active Time Before Strobe	
(Data Set-Up Time), t _{su(D)}	20 ns
Input Active Time After Strobe	
(Data Hold Time), t _{h(D)}	20 ns
Input Pulse Width, t _{w(D)}	40 ns
Input Logic High, V_{IH} \geq 0.8	35V _{DD}
Input Logic Low, V_{II} ≤ 0.1	$5V_{DD}$

TEST CIRCUITS



 $E_{AS} = I_{AS} \times V_{(BR)DSX} \times t_{AV}/2$

Single-Pulse Avalanche Energy Test Circuit and Waveforms

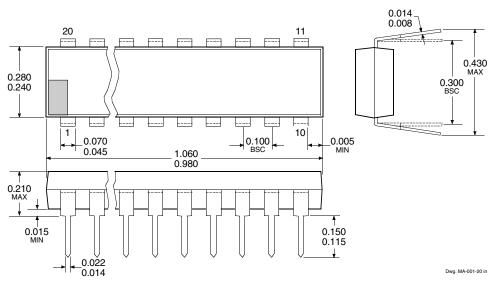


TERMINAL DESCRIPTIONS

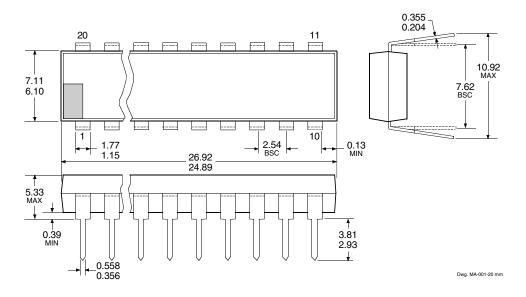
Terminal No.	Terminal Name	Function
1	CLEAR	When (active) LOW, all latches are reset and all outputs go HIGH (turn OFF).
2	IN ₁	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₁ = HIGH, OUT ₁ = LOW).
3	IN ₂	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₂ = HIGH, OUT ₂ = LOW).
4	OUT_1	Current-sinking, open-drain DMOS output.
5	OUT_2	Current-sinking, open-drain DMOS output.
6	OUT_3	Current-sinking, open-drain DMOS output.
7	OUT_4	Current-sinking, open-drain DMOS output.
8	IN_3	CMOS data input to a latch. When strobed, the output then inverts the data input (IN $_3$ = HIGH, OUT $_3$ = LOW).
9	IN_4	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₄ = HIGH, OUT ₄ = LOW).
10	GROUND	Reference terminal for all voltage measurements.
11	STROBE	A CMOS dynamic input to all latches. Data on each ${\rm IN_x}$ terminal is loaded into its associated latch on a low-to-high STROBE transition.
12	IN ₅	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₅ = HIGH, OUT ₅ = LOW).
13	IN ₆	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₆ = HIGH, OUT ₆ = LOW).
14	OUT ₅	Current-sinking, open-drain DMOS output.
15	OUT ₆	Current-sinking, open-drain DMOS output.
16	OUT ₇	Current-sinking, open-drain DMOS output.
17	OUT_8	Current-sinking, open-drain DMOS output.
18	IN ₇	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₇ = HIGH, OUT ₇ = LOW).
19	IN ₈	CMOS data input to a latch. When strobed, the output then inverts the data input (IN ₈ = HIGH, OUT ₈ = LOW).
20	LOGIC SUPPLY	(V _{DD}) The logic supply voltage (typically 5 V).

A6273KA

Dimensions in Inches (controlling dimensions)



Dimensions in Millimeters (for reference only)

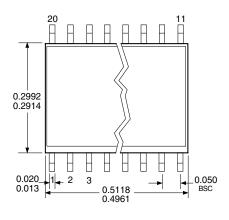


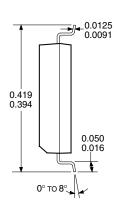
- NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.
 - 2. Lead spacing tolerance is non-cumulative.
 - 3. Lead thickness is measured at seating plane or below.

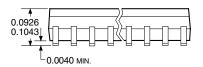


A6273KLW

Dimensions in Inches (for reference only)

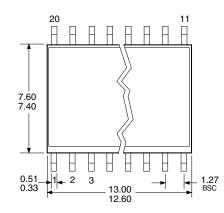


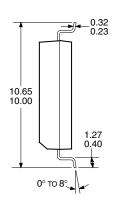


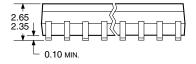


Dwg. MA-008-20 in

Dimensions in Millimeters (controlling dimensions)







Dwg. MA-008-20 mm

- NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.
 - 2. Lead spacing tolerance is non-cumulative.

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